L Number	Hits	Search Text	DB	Time stamp
-	91	427/255.26.ccls.	USPAT;	2004/04/27 12:49
1			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
i			IBM_TDB	
-	25	427/255.26.ccls. and diffuse	USPAT;	2004/04/27 12:54
			US-PGPUB;	
		•	EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	51	427/255.26.ccls. and diffus\$6	USPĀT;	2004/04/27 12:54
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
i -	15	427/255.26.ccls. and diffus\$6 near9 coat\$3	USPAT;	2004/04/27 12:56
		· ·	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	6	427/255.26.ccls. and diffus\$6 near9 contact	USPAT;	;; 2004/04/27 12:59 PUB; PO;
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	1	(427/255.26.ccls. and (plastic polymer\$3) near9 (substrate surface)) and	USPAT;	2004/04/27 13:16
		diffus\$6 near9 contact	US-PGPUB;	
		·	EPO; JPO;	
		·	DERWENT;	
		,	IBM TDB	
-	16	427/255.26.ccls. and (plastic polymer\$3) near9 (substrate surface)	USPAT;	2004/04/27 13:25
		(US-PGPUB;	
			EPO; JPO;	
1		·	DERWENT;	
			IBM TDB	
-	4	(427/255.26.ccls. and (plastic polymer\$3) near9 (substrate surface)) and	USPAT;	2004/04/27 13:19
		vapo\$1r\$8 near9 coat\$3	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
ļ			IBM TDB	
-	5	(427/255.26.ccls. and (plastic polymer\$3) near9 (substrate surface)) and	USPAT;	2004/04/27 13:20
		vapo\$1r\$8 near9 (coat\$3 modif\$8)	US-PGPUB;	
			EPO; JPO;	
	İ		DERWENT;	
			IBM_TDB	
-	1	(427/255.26.ccls. and (plastic polymer\$3) near9 (substrate surface)) and	USPAT;	2004/04/27 13:24
		vapo\$1r\$8 near9 (monomer\$3 \$9silane \$5amine)	US-PGPUB;	
	İ	,	EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	2096	((chemical near3 vapo\$1r near3 deposition) CVD) same (react\$9	USPAT;	2004/04/27 13:27
		covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) and	US-PGPUB;	11.0,5.127 15.27
		(plastic polymer\$3) near9 (substrate surface)	EPO; JPO;	
		• • • • • • • • • • • • • • • • • • • •	DERWENT;	
			IBM_TDB	
_	372	((chemical near3 vapo\$1r near3 deposition) CVD) same (react\$9	USPAT;	2004/04/27 13:27
		covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) same	US-PGPUB;	_00110111111111111111111111111111111111
		(plastic polymer\$3) near9 (substrate surface)	EPO; JPO;	
			DERWENT;	
			IBM TDB	_
	- J		םתו ואוחו	-

			Trop (**	0004/04/5= :-
	164	((chemical near3 vapo\$1r near3 deposition) CVD) near20 (react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) same (plastic polymer\$3) near9 (substrate surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 13:28
			IBM_TDB	
-	96	((chemical near3 vapo\$1r near3 deposition) CVD) near20 (react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) near20	USPAT; US-PGPUB;	2004/04/27 13:28
		(plastic polymer\$3) near9 (substrate surface)	EPO; JPO; DERWENT; IBM_TDB	
_	57	((chemical near3 vapo\$1r near3 deposition) CVD) near10 (react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) near10 (plastic polymer\$3) near9 (substrate surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 13:29
-	3	((chemical near3 vapo\$1r near3 deposition) CVD) near10 (react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) near10 (plastic polymer\$3) near9 (substrate surface) near9 ((heat\$3 hot) ((elevated raise\$3) near3 temperature))	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/27 13:42
-	231	(react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) same (plastic polymer\$3) near9 (substrate surface) near9 flame	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 13:44
- .	. 3770	(react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) near9 (plastic polymer\$3) and flame	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 13:44
-	188	(react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) near20 (plastic polymer\$3) near9 (substrate surface) near9 flame	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 13:46
-	4	vapo\$1r\$7 near9 (react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) near20 (plastic polymer\$3) near9 (substrate surface) near9 flame	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 13:48
-	12	vapo\$1r\$7 near9 (react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) and (plastic polymer\$3) near9 (substrate surface) near9 (heat\$3 flame) near9 activat\$9	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 14:03
-	671	vapo\$1r\$7 near9 (react\$9 covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) same (plastic polymer\$3) near9 (substrate surface)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 13:59
- . ·	253	vapo\$1r\$7 near9 (covalent\$3 bond\$5 attach\$6 graft\$3) near9 (substrate surface) near9 (plastic polymer\$3) near9 (substrate surface)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 14:21
-	32	vapo\$1r\$7 near9 (covalent\$3 graft\$3) near9 (substrate surface) near9 (plastic polymer\$3) near9 (substrate surface)	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/04/27 14:02
. -	451	vapo\$1r\$7 near9 (react\$9 covalent\$3 bond\$5 attach\$6) near9 (substrate surface) same (plastic polymer\$3) near3 (substrate surface)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	-2004/04/27 14:04
			DERWENT; IBM_TDB	

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-	452	vapo\$1r\$7 near9 (react\$9 covalent\$3 bond\$5) near9 (substrate surface) near15 (plastic polymer\$3) near3 (substrate surface)	USPAT; US-PGPUB;	2004/04/27 14:05
		Contract of the contract of th	EPO; JPO; DERWENT; IBM TDB	
-	413	vapo\$1r\$7 near9 (react\$9 covalent\$3 bond\$5) near9 (substrate surface) near9 (plastic polymer\$3) near3 (substrate surface)	USPAT; US-PGPUB; EPO; JPO;	2004/04/27 14:06
-	18	vapo\$1r\$7 near9 (react\$9 covalent\$3 bond\$5) near9 (substrate surface)	DERWENT; IBM_TDB USPAT;	2004/04/27 14:06
		near20 function\$9 near9 (plastic polymer\$3) near3 (substrate surface)	US-PGPUB; EPO; JPO; DERWENT;	
-	16	vapo\$1r\$7 near9 (react\$9 covalent\$3 bond\$5) near20 function\$9 near9 (plastic polymer\$3) near3 (substrate surface)	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/04/27 14:20
-	39	"5652021"	DERWENT; IBM_TDB USPAT; US-PGPUB;	2004/04/27 14:20
			EPO; JPO; DERWENT; IBM_TDB	2004/04/27
-	17	"5652021" and (plastic polymer\$3) near9 (substrate surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 14:36
-	3	(FILIPPOU near3 CON).in.	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/04/27 14:36
-	11	(GUTOWSKI near3 WOJCIECH).in.	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/04/27 14:36
-	. 29	(PROCTOR near3 DAVID).in.	DERWENT; IBM_TDB USPAT; US-PGPUB;	2004/04/27 14:37
-	7	(SPICER near3 MARK).in.	EPO; JPO; DERWENT; IBM_TDB USPAT;	2004/04/27 14:37
			US-PGPUB; EPO; JPO; DERWENT; IBM TDB	
-	42	((FILIPPOU near3 CON).in.) ((GUTOWSKI near3 WOJCIECH).in.) ((PROCTOR near3 DAVID).in.) ((SPICER near3 MARK).in.)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/27 14:37
-	7	(((FILIPPOU near3 CON).in.) ((GUTOWSKI near3 WOJCIECH).in.) ((PROCTOR near3 DAVID).in.) ((SPICER near3 MARK).in.)) and vapo\$1r\$6 and modif\$6	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/04/27 14:44
. -	43	diffus\$8 near3 contact near9 vapo\$1r\$6 near9 (substrate surface)	DERWENT; IBM_TDB USPAT; US-PGPUB;	2004/04/27 14:48
			EPO; JPO; DERWENT; IBM_TDB	

-	10	diffus\$8 near contact near9 vapo\$1r\$6 near9 (substrate surface)	USPAT;	2004/04/27 14:50
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	2004/04/25 14 52
•	3042	diffus\$8 near9 vapo\$1r\$6 near9 (substrate surface)	USPAT;	2004/04/27 14:52
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	132	(diffus\$8 near9 vapo\$1r\$6 near9 (substrate surface)) near9 chamber	USPAT;	2004/04/27 14:51
			US-PGPUB;	
•			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	1	(diffus\$8 near9 vapo\$1r\$6 near9 (substrate surface)) near9 chamber	USPAT;	2004/04/27 14:51
		near3 enclosed	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	7	(diffus\$8 near9 vapo\$1r\$6 near9 (substrate surface)) near9 enclosed	USPĀT;	2004/04/27 14:52
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	188	diffus\$8 near9 vapo\$1r\$6 near9 (substrate surface) near9 cvd	USPAT;	2004/04/27 14:54
	100	diffusion field y vaposition field (substrate surface) field y evu	US-PGPUB;	2004/04/27 14:54
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	8	diffus\$8 near9 vapo\$1r\$6 near9 (substrate surface) near9 (react\$6	USPAT;	2004/04/27 14:57
	•	bond\$3) near3 (covalent\$3 chemically)	US-PGPUB;	2004/04/27 14.57
		bondas) nears (covarentas chemicany)		
			EPO; JPO;	
			DERWENT;	
		difficette man 2 contact man to come that con the first man to the first m	IBM_TDB	2004/04/27 14:59
	0	diffus\$8 near3 contact near9 vapo\$1r\$6 near9 (\$9silane monomer\$3)	USPAT;	2004/04/27 14:58
		near9 (substrate surface)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	21	diffus\$8 near9 vapo\$1r\$6 near9 (\$9silane monomer\$3) near9 (substrate	USPAT;	2004/04/27 15:07
		surface)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	2	"5550001"	USPAT;	2004/04/27 15:07
			US-PGPUB;	
		·	EPO; JPO;	
			DERWENT;	
			IBM TDB	